

Si-Ti-N Alloy Negative Electrodes with Extremely High Thermal Stability for Li-Ion Batteries

Simeng Cao, Shayne Gracious and M.N. Obrovac

Department of Chemistry, Dalhousie University, 6274 Coburg Road, Halifax, Nova Scotia, Canada B3H 4R2

E-mail: simengcao@dal.ca

Si-Ti-N alloys are conventionally made by ball milling Si and TiN. We have found that such conventionally ball milled alloys crystallize during heating. Using a new method we prepared Si-Ti-N alloys with a unique microstructure allowing for high temperature thermal processing. X-ray diffraction patterns of thermally stable (TS) $\text{Si}_{70}\text{Ti}_{30}\text{N}_{30}$ and of the same sample heated to 800°C are shown in Figure 1. The XRD patterns are similar and are mainly made up of amorphous Si and nanocrystalline TiN. In contrast, conventional ball milled Si + TiN, underwent severe crystallization at 800°C (also shown in Figure 1).

The new thermally stable Si-Ti-N alloys are also more structurally stable during cycling and maintain their structural integrity even after heating to high temperatures. High temperature tolerance enables TS-Si-Ti-N alloys to be carbon coated at high temperature, which is an important method to improve performance of Si alloy electrode materials.

The microstructure, thermal stability and cell performance of TS-Si-Ti-N alloys with different stoichiometry will be presented, and reasons for their improved temperature tolerance will be discussed.

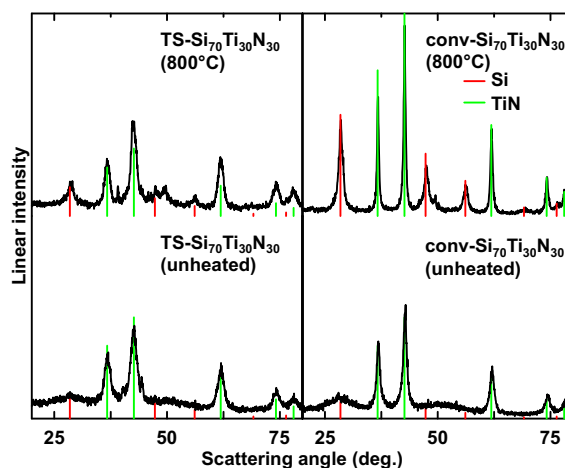


Figure 1 XRD patterns for unheated and heated TS-Si₇₀Ti₃₀N₃₀ conventional Si₇₀Ti₃₀N₃₀ samples.